Declaration and Power of Attorney For Patent Application English Language Declaration

	As a below named inventor, I hereby declare that:							
	My residence, pos	st office address a	and citizenship are as stated belo	ow next to my name,				
	first and joint inve for which a patent METHOD AND A JOINT BI-LEV	ntor (if plural nam t is sought on the PPARATUS FOR EL IMAGE GRO	R ENCODING IMAGE DATA	ct matter which is clai	imed and			
	the specification of	of which						
	(check one)							
#**	is attached he	reto.						
	was filed on as							
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	and was amer	nded on	(if applicable)					
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H Rad Man	I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.							
orte ours d'ond not une d'ond leue deux mile lui mile.	I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations § 1.56.							
	I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:							
	Prior Foreign Appl	lication(s)		Priority C	laimed			
	2000-046462 (Number)	_Japan (Country)	23/02/2000 (Day/Month/Year Filed)	Yes	No			
	(Number)	(Country)	(Day/Month/Year Filed)	\times	No			
	(Number)	(Country)	(Day/Month/Year Filed)	Yes	No			

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application:

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(Application Serial No.)	(Filing Date)	(Status) (patented, pending, abandoned)
(Application Serial No.)	(Filing Date)	(Status) (patented, pending, abandoned)
statements made on information and were made with the knowledge that by fine or imprisonment, or both, ur	d belief are believed to be it willful false statements ider Section 1001 of Title	own knowledge are true and that all true; and further that these statements and the like so made are punishable 18 of the United States Code and that the application or any patent issued

POWER OF ATTORNEY: As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith. (*list name and registration number*)

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